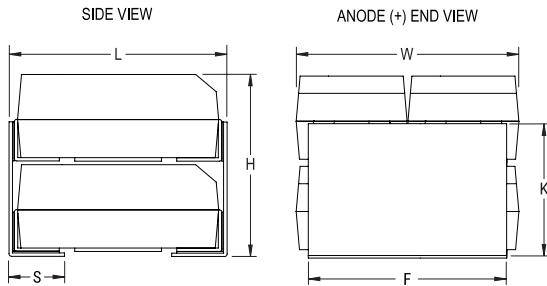


TSP, Tantalum, Polymer Tantalum, HRA, 130 uF, 10%, 10 VDC, 4B



General Information	
Series:	TSP
Dielectric:	Polymer Tantalum
Style:	Stacked Chip
Description:	SMD, Polymer, KO, Stacks, High Reliability
Features:	High Reliability
RoHS:	Yes
Termination:	Solder Coated
Termination (Stack):	Silver Plated
AEC-Q200:	No
MSL:	3

Dimensions	
Case Code	4B
L	4.1mm +/-0.38mm
W	6.1mm +/-0.2mm
H	4.3mm +/-0.38mm
S	0.76mm +/-0.38mm
F	5.3mm +/-0.2mm
K	3.1mm +/-0.38mm

Specifications	
Capacitance:	130 uF
Capacitance Tolerance:	10%
Voltage DC:	10 VDC (105C), 6.7 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	105°C
Dissipation Factor:	8% 120Hz 25C
Failure Rate:	C (0.01%/1000 Hrs)
Resistance:	20 mOhms (100kHz 25C)
Leakage Current:	132 uA (5min 25°C)
Testing and Reliability:	10 Cycles Surge Current Testing At +25C +/-5C After Voltage Aging

Packaging Specifications	
Packaging:	Tray
Packaging Quantity:	50

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)